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# Image Sensing Technologies: Materials, Devices, Systems, and Applications V

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### **Contents**

vii ix	Authors Conference Committee
	ADVANCED HYPERSPECTRAL IMAGING I
10656 03	Non-destructive rapid quality control method for tobacco grading using visible near-infrared hyperspectral imaging (Invited Paper) [10656-2]
10656 04	LED spectral imaging with food and agricultural applications (Invited Paper) [10656-3]
10656 05	Using unmanned aerial systems to collect hyperspectral imagery and digital elevation models at a legacy underground nuclear explosion test site (Invited Paper) [10656-4]
	ADVANCED HYPERSPECTRAL IMAGING II
10656 07	Synthetic neural network calibration of a hyperspectral imaging camera (Invited Paper) [10656-6]
10656 08	Itchy skin region detection using hyperspectral imaging (Invited Paper) [10656-7]
	ADVANCED IMAGING DEVICES: PHOTODETECTORS, X-RAY DETECTORS, BOLOMETERS
10656 0A	Tuning of temperature coefficient of resistivity in poly-crystalline VO <sub>2</sub> via chemical doping [10656-9]
10656 OB	Long-wave and mid-wave infrared micro-bolometers with gold black or wavelength-selective absorbers (Invited Paper) [10656-10]
	ADVANCED PHOTODETECTORS AND BOLOMETER
10656 0E	Material considerations for current and next generation microbolometer technology (Invited Paper) [10656-12]
10656 OF	Uncooled resistive metal foil bolometers for imaging with radiofrequency magnetic fields (Invited Paper) [10656-13]

10656 0G	Microwave bolometers based on carbon nanotube thin films and CVD-grown graphene (Invited Paper) [10656-14]
10656 OH	Customized packaged bolometers in niche applications at INO (Invited Paper) [10656-15]
	ADVANCED PHOTODETECTORS AND FOCAL PLANE ARRAY (FPA)
10656 OI	Low-noise, digital-alloy avalanche photodiodes (Invited Paper) [10656-16]
10656 OJ	A 400 KHz line rate 2048-pixel stitched SWIR linear array [10656-17]
10656 OK	Development of a hermetically packaged 13µm pixel pitch 6000-element InGaAs linear array [10656-18]
10656 OL	An extremely compact and high-speed line-scan hyperspectral imager covering the SWIR range (Invited Paper) [10656-19]
10656 ON	Analytical model for design-optimization and performances of fabricated broadband (VISSWIR) photodetector for image sensor and optical communication applications [10656-21]
	COMPUTATIONAL IMAGING II
10656 OS	Achieving fast high-resolution 3D imaging by combining synchrotron x-ray microCT, advanced algorithms, and high performance data management (Invited Paper) [10656-26]
	COMPUTATIONAL IMAGING III
10656 OU	High resolution 3D imaging of integrated circuits by x-ray ptychography (Invited Paper) [10656-28]
10656 OW	EUV photolithography mask inspection using Fourier ptychography (Invited Paper) [10656-30]
	ADVANCED IMAGING TECHNOLOGIES I
	AD TAILED INFORMS IDDINISTICATION
10656 OZ	Hardware based spatio-temporal neural processing backend for imaging sensors: towards a smart camera (Invited Paper) [10656-32]
10656 10	Considerations in the development of a foveated imaging system for unmanned aerial vehicles (UAVs) [10656-33]
10656 11	Novel high energy short-pulse laser diode source for 3D flash LIDAR [10656-34]

#### **ADVANCED IMAGING TECHNOLOGIES II** 10656 14 ROIC for 3 µm pixel pitch colloidal quantum dot detectors [10656-55] **ADVANCED THZ IMAGING TECHNOLOGIES I** 10656 15 Near-field microscopy of spontaneous evanescent waves (Invited Paper) [10656-37] 10656 17 Terahertz imagers based on metamaterial structures monolithically integrated in standard CMOS technologies (Invited Paper) [10656-39] ADVANCED THZ IMAGING TECHNOLOGIES II 10656 11 Explosive hazard defeat challenges and needs in future conflict and environment (Invited Paper) [10656-51] 10656 1L Using liquid water as broadband terahertz wave emitter (Invited Paper) [10656-45] **POSTER SESSION** Surface plasmon polariton mode validation using commercially available finite element 10656 10 method ANSYS HFSS [10656-59] 10656 1Q Hemispherical image sensor development for wide FOV imaging [10656-61] 10656 1R Adaptive test bench for characterizing image processing sensors [10656-62] 10656 1T Wide range UV irradiation system for imaging reflection spectroscopy [10656-64] 10656 1U Finite size narrow-band transmission filters for real-time short wave IR spectroscopy and **imaging** [10656-65] 10656 1V First demonstration of gate voltage-less chemical vapour deposition graphene for nonvacuum thermoelectric study [10656-66] Readout QDC for CdTe x-ray imager using direct charge treatment [10656-69] 10656 1W

#### **Authors**

Numbers in the index correspond to the last two digits of the seven-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first five digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Alain, Christine, 0H Amacher, Blake, 0G Anderson, Dylan, 05 Aoki, Toru, 1W Avrutin, Vitaliy, 1U Bakulin, A., 14 Bank, Seth R., OI Barnard, Harold, OS Béland, David, 0H Beletic, James W., 0K Benk, Markus P., OW Bergeron, Alain, 0H Bikov, Leonid, OL Bows, John, OS Briggs, Trevor, 05 Campbell, Joe C., 01

Canal, C., 11
Carstensen, Jens Michael, 04
Châteauneuf, François, 0H
Chuan, Kailiang, 1V
Craven, Julia M., 05
Cumming, David R. S., 17
Cyberey, Mike, 0A
Dai, Jianming, 1L
Dante, Henry, 03
Davidson, Joshua C., 10
De Gaspari, Danny, 0J
De Santis, Stefano, 0S
Desroches, Yan, 0H
Dhar, Nibir K., 0N, 10, 1U

Dufour, Denis, 0H Dutta, Achyut K., 0N Dutta, Jaydeep K., 0N Dzur, Robert, 05 E., Yiwen, 1L Ernst, Henrik, 1V Escorcia, Ivonne, 17

Douence, Vincent, 0K

D'Souza, A. I., 14

Finch, Michael F., 1O Fisette, Bruno, 0H Ganguly, Samiran, 0Z Gasper, Michael R., 0G Généreux, Francis, 0H Ghosh, Avik W., 0Z

Goh, Simon Chun Kiat, 1V Goldberg, Kenneth A., 0W

Gonzalez, Pilar, OL Gouveia, Luis, 17 Graf-Batuchtin, Ilja, 1R Grant, James P., 17 Green, Ryan B., 1U Gross, Miela, 0S Gu, Yunfei, 0Z

Guizar-Sicairos, Manuel, 0U Gunawidjaja, Ray, 0E Hamilton, Ian, 0S Harcrow, M. S., 0E Holler, Mirko, 0U Illmann, Raik, 1T Jennings, Jeffrey M., 0F

Jin, Qi, 1L

Jones, Chandler, 0S Kajihara, Yusuke, 15 Kane, Tim J., 10 Kar, Aravinda, 0F

Karempudi, Venkata Sai Praneeth, OG

Kim, Jongwoo, 0K Kim, Joong H., 11 Kimchi, Joe, 0K

Kittiwatanakul, Salinporn, OA

Klem, E., 14
Kohl, A., 11
Koike, Akifumi, 1W
Komiyama, Susumu, 15
Krasovitski, Leonid, 0L
Kudenov, Michael W., 07
Lail, Brian A., 10
Lambrechts, Andy, 0L
Laugustin, A., 11
Lee, Dennis J., 05

Li, C., 14

Lichtenberger, Arthur, 0A

Lin, Kuan-Ting, 15 Littler, C. L., 0E Lopes, V. C., 0E Lu, Jiwei, 0A Ma, Zhao, 1Q

Lei, Jih-Fen, OK

MacDowell, Alastair, 0S Marchese, Linda, 0H Masschelein, Bart, 0L Masterjohn, C., 14 McDougall, Tristan D., 0S

Mei, E., 14 Merken, Patrick, 0J Miller, Elizabeth, 05 Miranda, Félix A., 0G Narayanan, Ram M., 10 Naulleau, Patrick P., 0W Notni, Gunther, 1R, 1T Odstrcil, Michal, 0U Oduor, Patrick, 0N Olaogun, Olanrewaju P., 1O Oleksyuk, Vira. 08

Oleksyuk, Vira, 08 O'Neill, Andrew D., 10

Özgür, Ümit, 1U Pacold, Joseph, 0S

Parkinson, Dilworth Y., 0S

Parsa, Nitin, OG

Peale, Robert E., OB

Pelt, Daniel E., OS

Peterson, Anders, 0K

Peterson, Joshua, OS

Picard, Francis, 0H

Pichette, Julien, 0L

Proulx, Christian, 0H

Raabe, Jorg, 0U

Rabot, O., 11

Radtke, Lisa, 1R

Ramirez-Hong, Alvaro, 0S

Ratti, Alessandro, OS

Renshaw, C. Kyle, 1Q

Romanofsky, Robert R., 0G

Rosenberger, Maik, 1R, 1T

Sahu, Amrita, 03

Saleheen, Firdous, 08

Sauber, Noah, 0A

Scarboro, Clifton G., 07

Schultz-Fellenz, Emily, 05

Sethian, James, OS

Shiau, Li Lynn, 1V

Shuh, David K., OS

Sivarajan, Ramesh, 0G

Smiles, Danil E., 0S

Song, Kai, OK

Stan, Mircea R., 0Z

Starr, Brian, OK

Sundareswaran, Venkataraman, OK

Syllaios, A. J., 0E

Takagi, Katsuyuki, 1W

Takagi, Toshiyuki, 1W

Tay, Beng Kang, 1V

Temple, D., 14

Terao, Tsuyoshi, 1W

Terroux, Marc, 0H

Toonen, Ryan C., 0G

Topart, Patrice, 0H

Topsakal, Erdem, 1U

Treacy, Colleen E., 0G

Tremblay, Mathieu, 0H

Vaidyanathan, Raj, OF

Varaljay, Nicholas C., 0G Vereecke, Bart, 0L

Vervenne, Vincent, 0J

Vigil, Steven, 05

Vinella, Rosa Maria, 0J

Wang, Xingli, 1V

Weikle, Robert, 0A Western, B. J., 0E Williams, Kaia, 1L Wojdyla, Antoine, 0W Won, Chang-Hee, 08 Wouters, Kristof, 0J Yu, Zhi-Gang, 0E Yuan, Henry, 0K

Zhang, X.-C., 1L

viii

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5 Advanced Photodetectors and Focal Plane Array (FPA)

**Arvind I. D'Souza**, DRS Sensors & Targeting Systems, Inc. (United States)

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7 Computational Imaging II

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**Aamod Shanker**, University of California, Berkeley (United States)

8 Computational Imaging III

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**Aamod Shanker**, University of California, Berkeley (United States)

9 Advanced Imaging Technologies I

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Achyut K. Dutta, Banpil Photonics, Inc. (United States)

10 Advanced Imaging Technologies II

**Nibir K. Dhar**, U.S. Army Night Vision & Electronic Sensors Directorate (United States)

Achyut K. Dutta, Banpil Photonics, Inc. (United States)

11 Advanced THz Imaging Technologies I

**Hou-Tong Chen**, The Center for Integrated Nanotechnologies (United States)

Seongsin Margaret Kim, The University of Alabama (United States)

12 Advanced THz Imaging Technologies II

**Hou-Tong Chen**, The Center for Integrated Nanotechnologies (United States)

**Seongsin Margaret Kim**, The University of Alabama (United States)